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		Subclass
	Class	ISSUE CLASSIFICATION

PATENT NUMBER

U.S. UTILITY Patent Application

TMB O.I.P.E.
SCANNED *ACT* Q.A. *WBS*

PATENT DATE

APPLICATION NO. 09/892630	CONT/PRIOR F	CLASS 228	SUBCLASS 174	ART UNIT 1725 2802	EXAMINER Q - JV
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PLICANTS
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Lead-free solder and connection lead and electrical component using said lead-free solder

PTO-2040
12/99

ISSUING CLASSIFICATION

TERMINAL DISCLAIMER		DRAWINGS			CLAIMS ALLOWED	
		Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.					NOTICE OF ALLOWANCE MAILED	
<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S Patent. No. _____ _____ _____					ISSUE FEE	
<input type="checkbox"/> The terminal ____ months of this patent have been disclaimed.					Amount Due	Date Paid
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